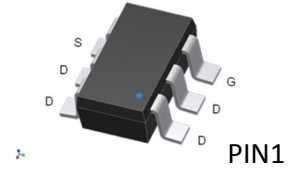
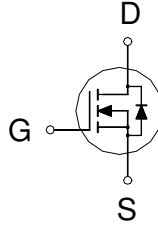


N-Channel Logic Level Enhancement Mode Field Effect Transistor

Product Summary:

BV _{DSS}	30V
R _{DS(on)} (MAX.)	27mΩ
I _D	6A

N-Channel MOSFET



Pb-Free Lead Plating & Halogen Free



ABSOLUTE MAXIMUM RATINGS (T_A = 25 °C Unless Otherwise Noted)

PARAMETERS/TEST CONDITIONS		SYMBOL	LIMITS	UNIT
Gate-Source Voltage		V _{GS}	±20	V
Continuous Drain Current	T _A = 25 °C	I _D	6	A
	T _A = 70 °C		4	
Pulsed Drain Current ¹		I _{DM}	24	
Power Dissipation	T _A = 25 °C	P _D	1.92	W
	T _A = 70 °C		1.23	
Operating Junction & Storage Temperature Range		T _J , T _{stg}	-55 to 150	°C

THERMAL RESISTANCE RATINGS

THERMAL RESISTANCE	SYMBOL	TYPICAL	MAXIMUM	UNIT
Junction-to-Ambient ³	R _{θJA} (T ≤ 10sec)		65	°C / W
	R _{θJA} (Steady State)		100	

¹Pulse width limited by maximum junction temperature.

²Duty cycle ≤ 1%

³Pulse width limited by maximum junction temperature.

ELECTRICAL CHARACTERISTICS (T_J = 25 °C, Unless Otherwise Noted)

PARAMETER	SYMBOL	TEST CONDITIONS	LIMITS			UNIT
			MIN	TYP	MAX	
STATIC						
Drain-Source Breakdown Voltage	V _{(BR)DSS}	V _{GS} = 0V, I _D = 250μA	30			V
Gate Threshold Voltage	V _{GS(th)}	V _{DS} = V _{GS} , I _D = 250μA	1.0	1.7	3.0	
Gate-Body Leakage	I _{GSS}	V _{DS} = 0V, V _{GS} = ±20V			±100	nA
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = 24V, V _{GS} = 0V			1	μA
		V _{DS} = 20V, V _{GS} = 0V, T _J = 125 °C			10	
On-State Drain Current ¹	I _{D(ON)}	V _{DS} = 5V, V _{GS} = 10V	6			A
Drain-Source On-State Resistance ¹	R _{DS(ON)}	V _{GS} = 10V, I _D = 6A		21	27	mΩ
		V _{GS} = 4.5V, I _D = 5A		32	40	
Forward Transconductance ¹	g _{fs}	V _{DS} = 5V, I _D = 6A		12		S
DYNAMIC						
Input Capacitance	C _{iss}	V _{GS} = 0V, V _{DS} = 15V, f = 1MHz		522		pF
Output Capacitance	C _{oss}			105		
Reverse Transfer Capacitance	C _{rss}			82		
Total Gate Charge ^{1,2}	Q _g	V _{DS} = 15V, V _{GS} = 10V, I _D = 6A		10.9		nC
Gate-Source Charge ^{1,2}	Q _{gs}			1.75		
Gate-Drain Charge ^{1,2}	Q _{gd}			3.4		
Turn-On Delay Time ^{1,2}	t _{d(on)}	V _{DS} = 15V, I _D = 1A, V _{GS} = 10V, R _{GS} = 6Ω		8		nS
Rise Time ^{1,2}	t _r			7		
Turn-Off Delay Time ^{1,2}	t _{d(off)}			15		
Fall Time ^{1,2}	t _f			10		
SOURCE-DRAIN DIODE RATINGS AND CHARACTERISTICS (T_c = 25 °C)						
Continuous Current	I _S				2	A
Pulsed Current ³	I _{SM}				8	
Forward Voltage ¹	V _{SD}	I _F = I _S , V _{GS} = 0V			1.2	V

¹Pulse test : Pulse Width ≤ 300 μsec, Duty Cycle ≤ 2%.

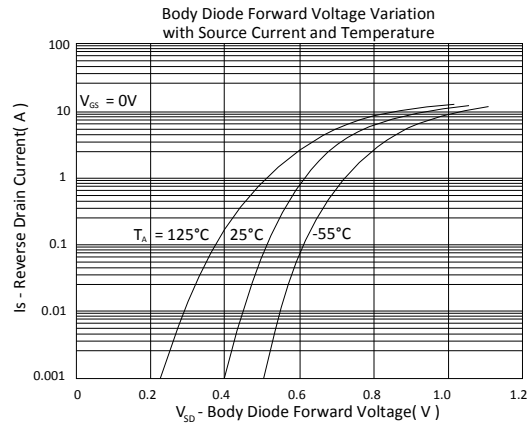
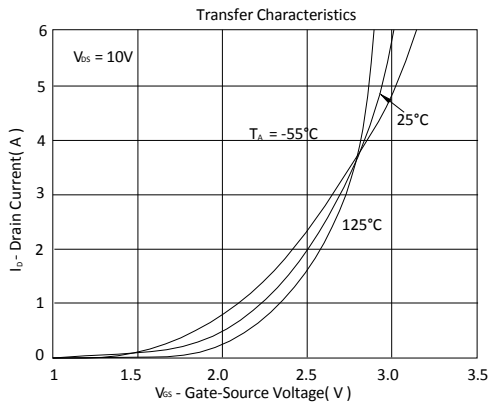
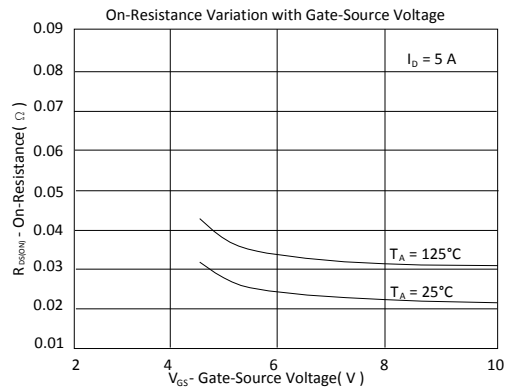
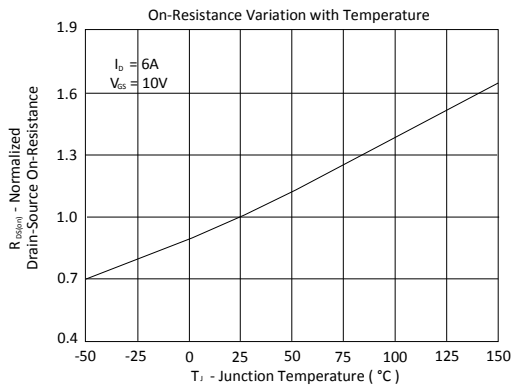
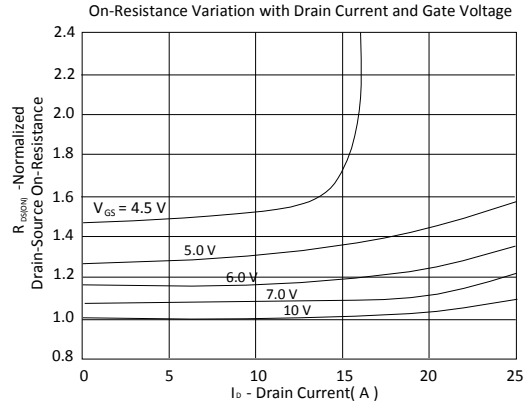
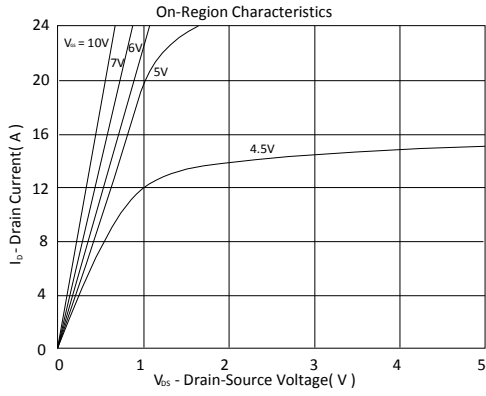
²Independent of operating temperature.

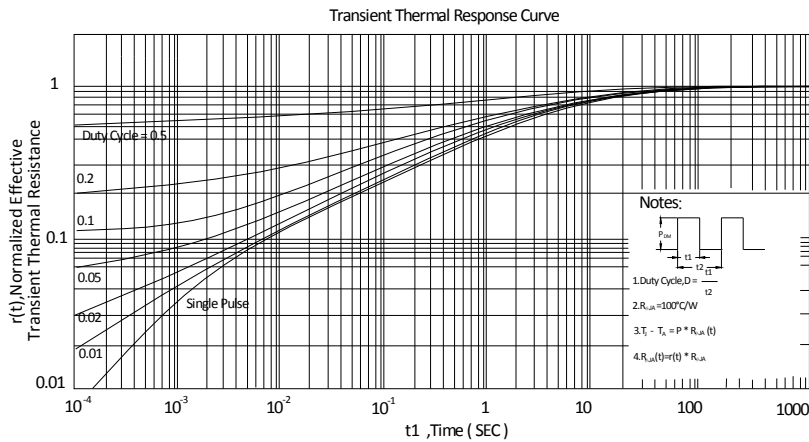
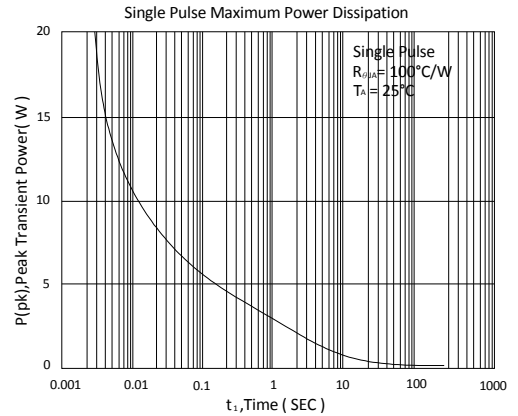
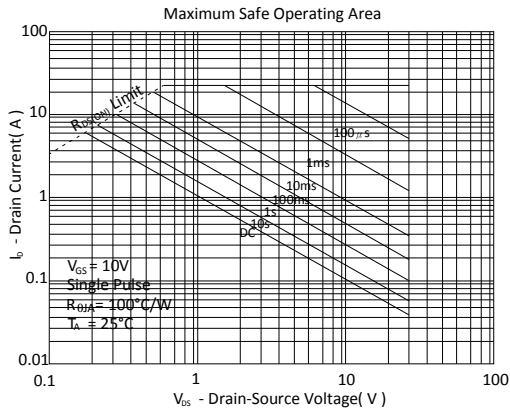
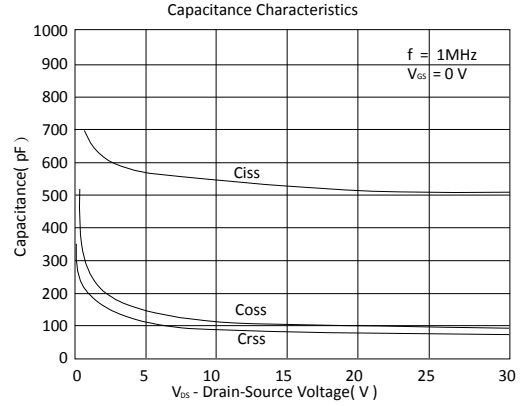
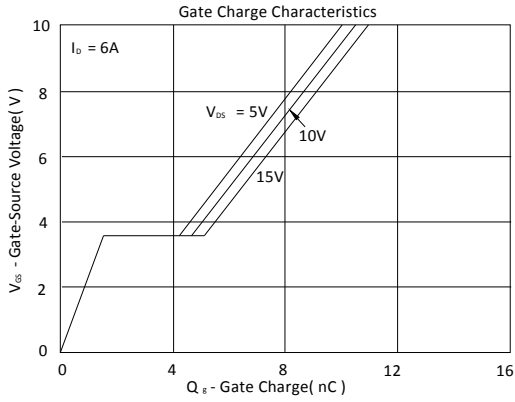
³Pulse width limited by maximum junction temperature.

EMC will review datasheet by quarter, and update new version.



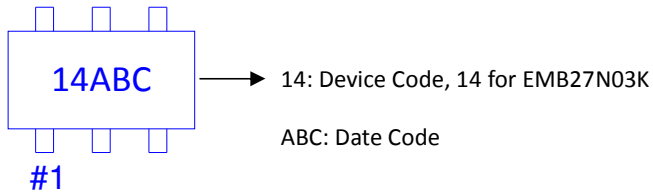
TYPICAL CHARACTERISTICS



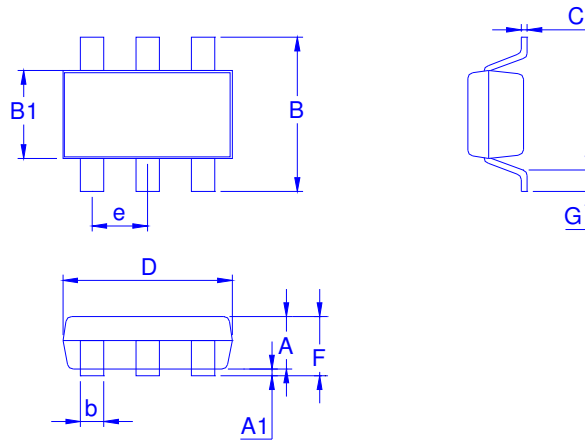


Ordering & Marking Information:

Device Name: EMB27N03K for TSOT23-6



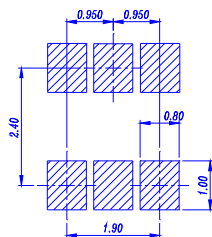
Outline Drawing



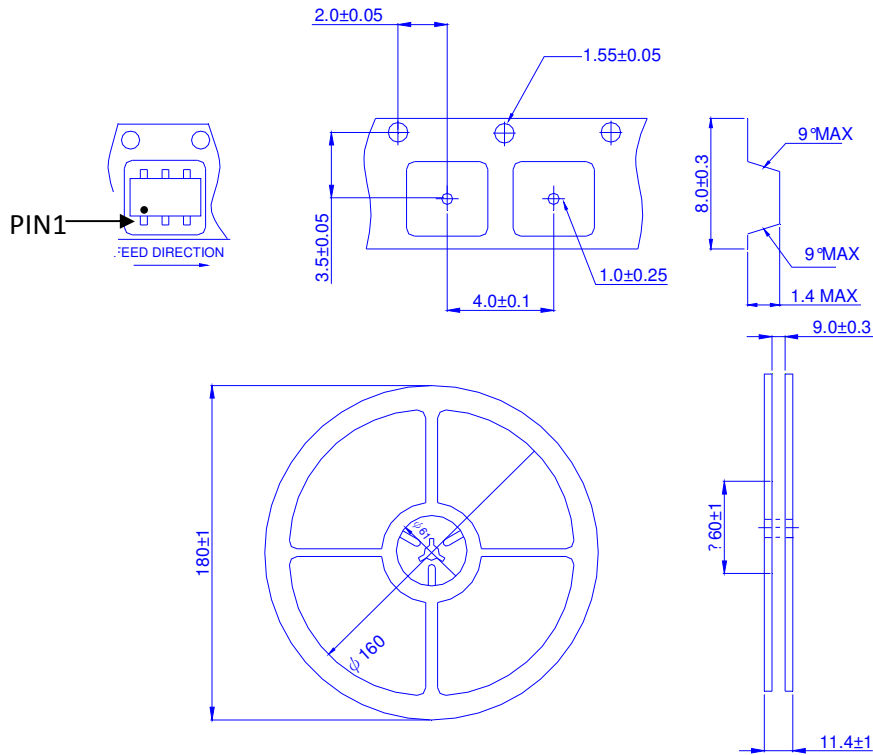
Dimension in mm

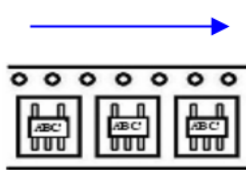
Dimension	A	A1	B	B1	b	C	D	e	F	G
Min.	0.70	0	2.50	1.50	0.30	0.08	2.70		0.70	0.30
Typ.	0.95		2.80	1.60	0.40		2.90	0.95		
Max.	1.00	0.10	3.10	1.70	0.50	0.20	3.10		1.10	0.60

Footprint



◆ Tape&Reel Information:3000pcs/Reel(Dimension in millimeter)



產品別	TSOT23-6
Reel 尺寸	7"
編帶方式	FEED DIRECTION 
前空格	50
後空格	50
裝箱數	
滿捲數量	3K
捲/內盒比	5 : 1
內盒滿箱數	15K
內/外箱比	12 : 1
外箱滿箱數	180K